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	70855050-X		
	A3	A1	0755-33810388
	(Printed Circuit Board PCB) (High Density Interconnection HDI) (Flexible Printed Circuit FPC) (Rigid Printed Circuit Board 3C ISO9001 ISO14001 ISO14064 OHSAS18001 QC080000		

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		17.42
		20.72
		8.82
		2.83
		14.06
		39.68
		7.82
		1.07
		0.76
		64.81
		168.09

	Leq	Leq	Leq	Leq	
1	57.9	47.4	65	55	
1	58.2	47.7			
1	58.7	48.2			
1	58.1	47.7			

		2006 12	12000 /	
		2006 12	133.3 /	

()		2005-12- 23	[2005] 213			
()		2009-09- 08	[2009] 10091 7			

()					2007/ 7/19	[2007] 075
()					2009/ 2/9	[2009] 021
()					2011/4 /11	[2011] 026

			2014-3-10
1	"		
2	"		

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	<p>http://www.epinfo.org</p> <p>2013 12 16 2015</p> <p> 2015 10 23</p>
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	1.	COD	pH			
	2.			2011	3	31
				2019	3	31
	3.				500	RMB

2016年3月15日